

Vishay Semiconductors

# Schottky Rectifier, 2 x 20 A

# VS-MBRB4045CT+M3 VS-MBR4045CT-1HM3 Base common common cathode cathode 2 2

D<sup>2</sup>PAK

Common 0 3

cathode Anode

TO-262

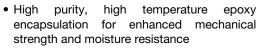
Anode

Common  $\circlearrowleft$  3 cathode Anode

PRODUCT SUMMARY					
Package	TO-263AB (D <sup>2</sup> PAK), TO-262AA				
I <sub>F(AV)</sub>	2 x 20 A				
$V_R$	45 V				
V <sub>F</sub> at I <sub>F</sub>	0.58 V				
I <sub>RM</sub> max.	95 mA at 125 °C				
T <sub>J</sub> max.	150 °C				
Diode variation	Common cathode				
E <sub>AS</sub>	20 mJ				

#### **FEATURES**

- 150 °C T<sub>J</sub> operation
- Low forward voltage drop
- · High frequency operation





- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201 class 1A whisker test
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **DESCRIPTION**

The center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL CHARACTERISTICS VALUES UNIT								
I <sub>F(AV)</sub>	Rectangular waveform (per device)	40	Λ.					
I <sub>FRM</sub>	T <sub>C</sub> = 117 °C (per leg)	40	A A					
V <sub>RRM</sub>		45	V					
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	900	A					
V <sub>F</sub>	20 A <sub>pk</sub> , T <sub>J</sub> = 125 °C	0.58	V					
T <sub>J</sub>	Range	-65 to 150	°C					

VOLTAGE RATINGS								
PARAMETER SYMBOL VS-MBR84045CTHM3 UNITS								
Maximum DC reverse voltage	$V_{R}$	45	V					
Maximum working peak reverse voltage	$V_{RWM}$	45	V					

ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST CONDI	TIONS	VALUES	UNITS				
Maximum average per leg	1	T <sub>C</sub> = 118 °C, rated V <sub>B</sub>	T 410 00 material V						
forward current per device	I <sub>F(AV)</sub>	IC = ITO C, Taled VR	IC = 110 C, rated V <sub>R</sub>						
Peak repetitive forward current per leg	I <sub>FRM</sub>	Rated V <sub>R</sub> , square wave, 20 kHz	z, T <sub>C</sub> = 117 °C	40	Α				
Maximum peak one cycle non-repetitive		5 μs sine or 3 μs rect. pulse	Following any rated	900					
peak surge current per leg	I <sub>FSM</sub>	10 ms sine or 6 ms rect. pulse	load condition and with rated V <sub>RRM</sub> applied	210					
Non-repetitive avalanche energy per leg	E <sub>AS</sub>	$T_J = 25  ^{\circ}\text{C},  I_{AS} = 3  \text{A},  L = 4.4  \text{mH}$		20	mJ				
Repetitive avalanche current per leg	I <sub>AR</sub>	Current decaying linearly to zer Frequency limited by T <sub>J</sub> maxim	3	Α					

Revision: 06-Mar-14 Document Number: 94721



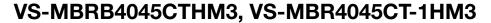
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ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS		
		20 A	T <sub>.1</sub> = 25 °C	0.60	V		
Maximum farward voltage drop	V <sub>FM</sub> <sup>(1)</sup>	40 A	1J=25 C	0.80			
Maximum forward voltage drop	VFM ('')	20 A	T <sub>.1</sub> = 125 °C	0.58			
		40 A	1J = 125 C	0.80			
	I <sub>RM</sub> <sup>(1)</sup>	T <sub>J</sub> = 25 °C		1	mA		
Maximum instantaneous reverse current		T <sub>J</sub> = 100 °C	Rated DC voltage	50			
Tovoise darrone		T <sub>J</sub> = 125 °C		95			
Maximum junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 5 V <sub>DC</sub> (test signal ran	900	pF			
Typical series inductance	L <sub>S</sub>	Measured from top of terr	8.0	nH			
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>	Rated V <sub>R</sub>				

#### Note

 $<sup>^{(1)}</sup>$  Pulse width < 300  $\mu$ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction temperature range	TJ		-65 to 150	°C				
Maximum storage temperature range	T <sub>Stg</sub>		-65 to 175	O				
Maximum thermal resistance, junction to case per leg	R <sub>thJC</sub>	DC operation	1.5					
Typical thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, smooth and greased (Only for TO-220)		°C/W				
Maximum thermal resistance, junction to ambient	R <sub>thJA</sub>	DC operation (For D <sup>2</sup> PAK and TO-262)	50					
Approximate weight			2	g				
Approximate weight			0.07	OZ.				
Mounting torque minimum		Non-lubricated threads	6 (5)	kgf · cm				
Mounting torque maximum		Non-lubricated trireads	12 (10)	(lbf $\cdot$ in)				
Marking daying		Case style D <sup>2</sup> PAK	MBRB4	045CTH				
Marking device		Case style TO-262	se style TO-262 MBR4045CT					





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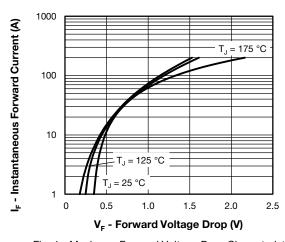


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

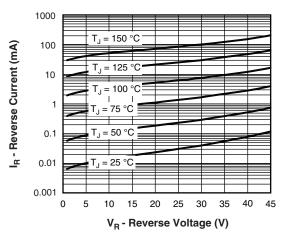


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

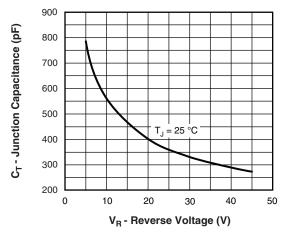


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

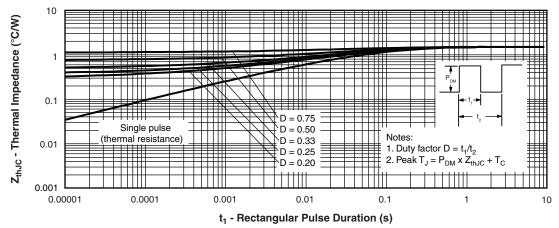


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics (Per Leg)



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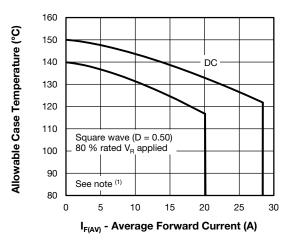


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

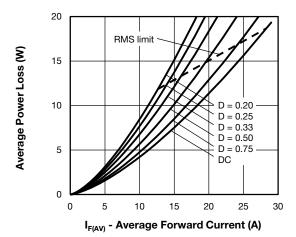


Fig. 6 - Forward Power Loss Characteristics

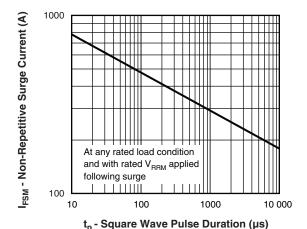


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

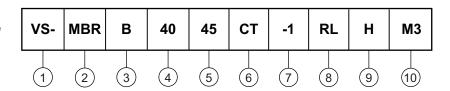
#### Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \text{Forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{Inverse power loss} = V_{R1} \times I_R \text{ (1 - D); } I_R \text{ at } V_{R1} = \text{Rated } V_R \\ \end{array}$ 

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#### **ORDERING INFORMATION TABLE**

Device code



Vishay Semiconductors product

2 - Essential part number

- • B =  $D^2PAK$  7 None

• None = TO-262 7 = -1

- Current rating (40 = 40 A)

- Voltage rating (45 = 45 V)

CT = Essential part number

• None =  $D^2PAK$  3 = B

• -1 = TO-262 • None = Tube

• L = Tape and reel (left oriented - for D<sup>2</sup>PAK only)

• R = Tape and reel (right oriented - for D<sup>2</sup>PAK only)

None

9 - H = AEC-Q101 qualified

10 - Environmental digit:

8

M3 = Halogen-free, RoHS-compliant and termination lead (Pb)-free

ORDERING INFORMATION (Example)								
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION					
VS-MBRB4045CTHM3	50	1000	Antistatic plastic tube					
VS-MBR4045CT-1HM3	50	1000	Antistatic plastic tube					
VS-MBRB4045CTLHM3	800	800	13" diameter reel					
VS-MBRB4045CTRHM3	800	800	13" diameter reel					

LINKS TO RELATED DOCUMENTS						
Dimensions	TO-263AB (D <sup>2</sup> PAK)	www.vishay.com/doc?95046				
Differsions	TO-262AA	www.vishay.com/doc?95419				
Part marking information	TO-263AB (D <sup>2</sup> PAK)	www.vishay.com/doc?95444				
Fart marking information	TO-262AA	www.vishay.com/doc?95443				
Packaging information	TO-263AB (D <sup>2</sup> PAK)	www.vishay.com/doc?95032				



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## D<sup>2</sup>PAK

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INC	HES	NOTES	NOTES SYMBOL	MILLIM	ETERS	INC	HES	NOTES	
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOIES	IES SYMBOL	STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	) BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

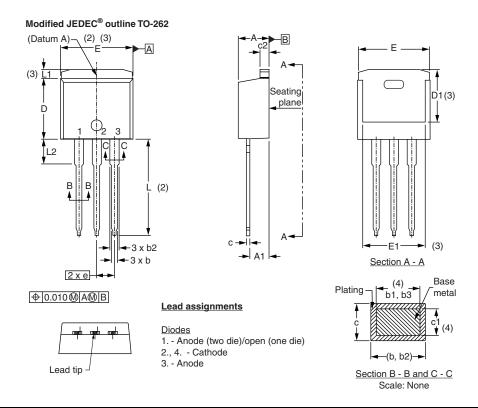
#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB

# Vishay Semiconductors

## **TO-262**

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIM	IETERS	INC	INCHES		
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.06	4.83	0.160	0.190		
A1	2.03	3.02	0.080	0.119		
b	0.51	0.99	0.020	0.039		
b1	0.51	0.89	0.020	0.035	4	
b2	1.14	1.78	0.045	0.070		
b3	1.14	1.73	0.045	0.068	4	
С	0.38	0.74	0.015	0.029		
c1	0.38	0.58	0.015	0.023	4	
c2	1.14	1.65	0.045	0.065		
D	8.51	9.65	0.335	0.380	2	
D1	6.86	8.00	0.270	0.315	3	
E	9.65	10.67	0.380	0.420	2, 3	
E1	7.90	8.80	0.311	0.346	3	
е	2.54 BSC		0.10	D BSC		
L	13.46	14.10	0.530	0.555		
L1	-	1.65	-	0.065	3	
L2	3.36	3.71	0.132	0.146		

#### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- 5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum), D1 (minimum) and L2 where dimensions derived the actual package outline

Revision: 11-Jul-2019 1 Document Number: 95419

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